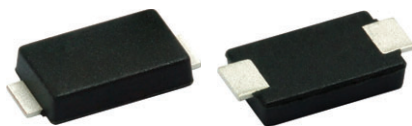


Surface-Mount PAR[®] Transient Voltage Suppressors

High Temperature Stability and High Reliability Conditions

eSMP[®] Series



Top View

Bottom View

SlimSMA (DO-221AC)

Cathode  Anode

LINKS TO ADDITIONAL RESOURCES


[3D Models](#)

[Related Documents](#)

[Packages](#)

[Marking](#)

PRIMARY CHARACTERISTICS

V_{BR}	6.8 V to 100 V
V_{WM}	5.8 V to 85.5 V
P_{PPM} (10 x 1000 μ s)	600 W
P_D at $T_M = 65^\circ\text{C}$	8 W
T_J max.	185 $^\circ\text{C}$
Polarity	Unidirectional
Package	SlimSMA (DO-221AC)

FEATURES

- Very low profile - typical height of 0.95 mm
- Junction passivation optimized design passivated anisotropic rectifier technology
- $T_J = 185^\circ\text{C}$ capability suitable for high reliability and automotive requirement
- Ideal for automated placement
- Unidirectional
- Excellent clamping capability
- Peak pulse power: 600 W (10/1000 μ s)
- AEC-Q101 qualified
- ESD protection up to 30 kV per IEC 61000-4-2
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 $^\circ\text{C}$
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

AUTOMOTIVE
GRADE

RoHS
COMPLIANT
HALOGEN
FREE

TYPICAL APPLICATIONS

Use in sensitive electronics protection against voltage transients induced by inductive load switching and lightning on ICs, MOSFET, signal lines of sensor units for automotive.

MECHANICAL DATA

Case: SlimSMA (DO-221AC)

Molding compound meets UL 94 V-0 flammability rating

Base P/NHM3_X - halogen-free, RoHS-compliant and AEC-Q101 qualified (“_X” denotes revision code e.g. A, B,.....)

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD22-B102

HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$, unless otherwise noted)

PARAMETER	SYMBOL	VALUE	UNIT
Peak pulse power dissipation with a 10/1000 μ s waveform	P_{PPM} ⁽¹⁾	600	W
Peak pulse current with a 10/1000 μ s waveform	I_{PPM} ⁽¹⁾	See next table	A
Power dissipation	$T_M = 65^\circ\text{C}$	P_D ⁽²⁾	W
	$T_A = 25^\circ\text{C}$	P_D ⁽³⁾	
Operating junction and storage temperature range	T_J, T_{STG}	-65 to +185	$^\circ\text{C}$

Notes

⁽¹⁾ Non-repetitive current pulse, per fig. 3 and derated above $T_A = 25^\circ\text{C}$ per fig. 2

⁽²⁾ Power dissipation mounted on infinite heat sink

⁽³⁾ Power dissipation mounted on minimum recommended pad layout

**ELECTRICAL CHARACTERISTICS** ($T_A = 25^\circ\text{C}$ unless otherwise noted)

DEVICE TYPE	DEVICE MARKING CODE	BREAKDOWN VOLTAGE $V_{BR}^{(1)}$ AT I_T (V)			TEST CURRENT I_T (mA)	STAND-OFF VOLTAGE V_{WM} (V)	MAXIMUM REVERSE LEAKAGE AT V_{WM} I_R (μA)	$T_J = 150^\circ\text{C}$ MAXIMUM REVERSE LEAKAGE AT V_{WM} I_R (μA)	MAXIMUM PEAK PULSE SURGE CURRENT I_{PPM} (A)	MAXIMUM CLAMPING VOLTAGE AT I_{PPM} V_C (V)	TYPICAL TEMP. COEFFICIENT OF $V_{BR}^{(2)}$ α_T ($\%/^\circ\text{C}$)
		MIN.	NOM.	MAX.							
TA6F6.8A	AEP	6.45	6.80	7.14	10	5.80	500	1000	57.1	10.5	0.047
TA6F7.5A	AGP	7.13	7.50	7.88	10	6.40	250	500	53.1	11.3	0.052
TA6F8.2A	AKP	7.79	8.20	8.61	10	7.02	100	200	49.6	12.1	0.056
TA6F9.1A	AMP	8.65	9.10	9.55	1.0	7.78	25	50	44.8	13.4	0.060
TA6F10A	APP	9.5	10.0	10.5	1.0	8.55	5.0	20	41.4	14.5	0.064
TA6F11A	ARP	10.5	11.0	11.6	1.0	9.40	2.0	5.0	38.5	15.6	0.067
TA6F12A	ATP	11.4	12.0	12.6	1.0	10.2	2.0	5.0	35.9	16.7	0.070
TA6F13A	AVP	12.4	13.0	13.7	1.0	11.1	2.0	5.0	33.0	18.2	0.072
TA6F15A	AXP	14.3	15.0	15.8	1.0	12.8	1.0	5.0	28.3	21.2	0.076
TA6F16A	AZP	15.2	16.0	16.8	1.0	13.6	1.0	5.0	26.7	22.5	0.078
TA6F18A	BEP	17.1	18.0	18.9	1.0	15.3	1.0	5.0	23.5	25.5	0.080
TA6F20A	BGP	19.0	20.0	21.0	1.0	17.1	1.0	5.0	21.7	27.7	0.082
TA6F22A	BKP	20.9	22.0	23.1	1.0	18.8	1.0	5.0	19.6	30.6	0.084
TA6F24A	BMP	22.8	24.0	25.2	1.0	20.5	1.0	5.0	18.1	33.2	0.085
TA6F27A	BPP	25.7	27.0	28.4	1.0	23.1	1.0	5.0	16.0	37.5	0.087
TA6F30A	BRP	28.5	30.0	31.5	1.0	25.6	1.0	5.0	14.5	41.4	0.088
TA6F33A	BTP	31.4	33.0	34.7	1.0	28.2	1.0	5.0	13.1	45.7	0.089
TA6F36A	BVP	34.2	36.0	37.8	1.0	30.8	1.0	5.0	12.0	49.9	0.090
TA6F39A	BXP	37.1	39.0	41.0	1.0	33.3	1.0	5.0	11.1	53.9	0.091
TA6F43A	BZP	40.9	43.0	45.2	1.0	36.8	1.0	10.0	10.1	59.3	0.092
TA6F47A	CEP	44.7	47.0	49.4	1.0	40.2	1.0	10.0	9.3	64.8	0.092
TA6F51A	CGP	48.5	51.0	53.6	1.0	43.6	1.0	10.0	8.6	70.1	0.093
TA6F56A	CKP	53.2	56.0	58.8	1.0	47.8	1.0	10.0	7.8	77.0	0.096
TA6F62A	CMP	58.9	62.0	65.1	1.0	53.0	1.0	10.0	7.1	85.0	0.096
TA6F68A	CPP	64.6	68.0	71.4	1.0	58.1	1.0	10.0	6.5	92.0	0.097
TA6F75A	CRP	71.3	75.0	78.8	1.0	64.1	1.0	10.0	5.8	104	0.097
TA6F82A	CTP	77.9	82.0	86.1	1.0	70.1	1.0	10.0	5.3	113	0.097
TA6F91A	CVP	86.5	91.0	95.6	1.0	77.8	1.0	15.0	4.8	125	0.098
TA6F100A	CXP	95.0	100	105	1.0	85.5	1.0	15.0	4.4	137	0.098

Notes(1) Pulse test: $t_p \leq 50$ ms(2) To calculate V_{BR} vs. junction temperature, use the following formula: V_{BR} at $T_J = V_{BR}$ at $25^\circ\text{C} \times (1 + \alpha_T \times (T_J - 25))$ **THERMAL CHARACTERISTICS** ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Thermal resistance	$R_{\theta JA}^{(1)}$	120	150	$^\circ\text{C/W}$
	$R_{\theta JM}^{(2)}$	12	15	$^\circ\text{C/W}$

Notes

(1) Thermal resistance junction-to-ambient to follow JEDEC® 51-2A, device mounted on FR4 PCB, 2 oz. standard footprint

(2) Thermal resistance junction-to-mount to follow JEDEC® 51-14, using TDIM (transient dual interface test method)

IMMUNITY TO STATIC ELECTRICAL DISCHARGE TO THE FOLLOWING STANDARDS($T_A = 25^\circ\text{C}$ unless otherwise noted)

STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	VALUE
IEC 61000-4-2	Contact discharge	$C = 150$ pF, $R = 330$ Ω	ESD	30 kV
	Air discharge			30 kV

ORDERING INFORMATION (Example)

PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
TA6F6.8AHM3_A/H ⁽¹⁾	0.032	H	3500	7" diameter plastic tape and reel
TA6F6.8AHM3_A/I ⁽¹⁾	0.032	I	14 000	13" diameter plastic tape and reel

Note

(1) AEC-Q101 qualified



RATINGS AND CHARACTERISTICS CURVES ($T_A = 25^\circ\text{C}$ unless otherwise noted)

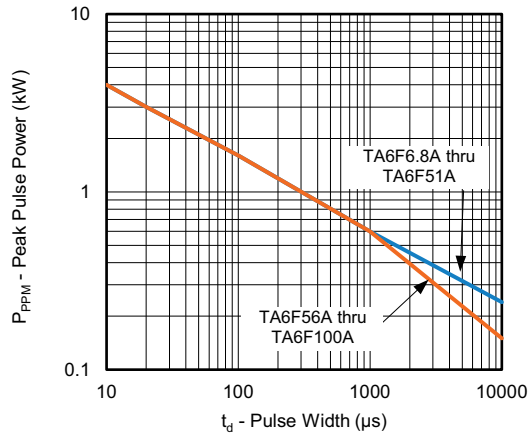


Fig. 1 - Peak Pulse Power Rating Curve

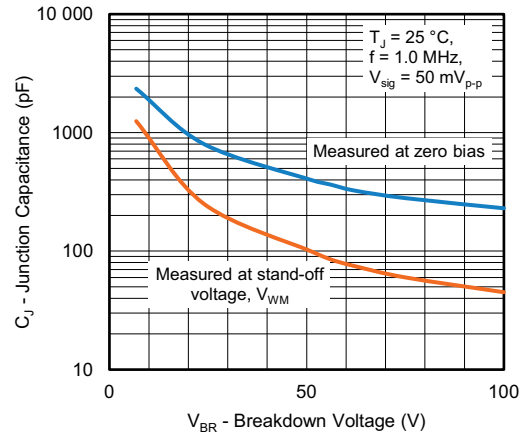


Fig. 4 - Typical Junction Capacitance

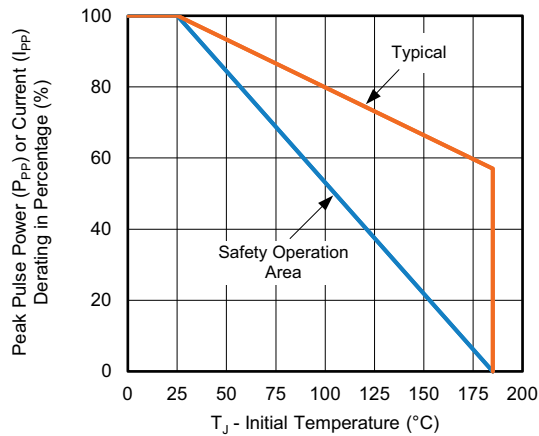


Fig. 2 - Pulse Power or Current vs. Initial Junction Temperature

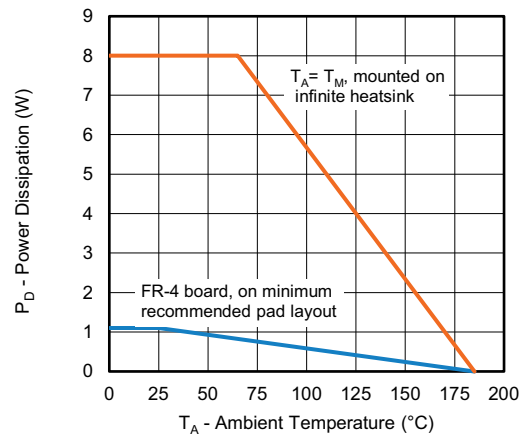


Fig. 5 - Power Dissipation Derating Curve

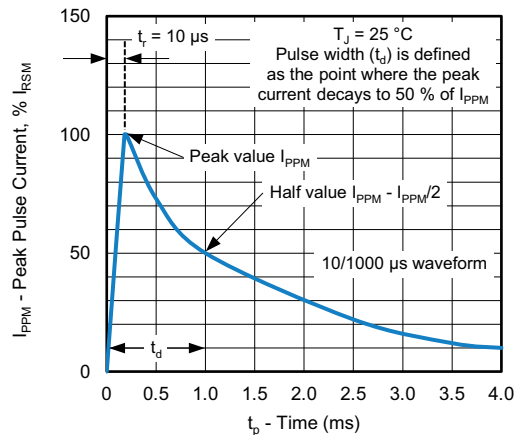


Fig. 3 - Pulse Waveform

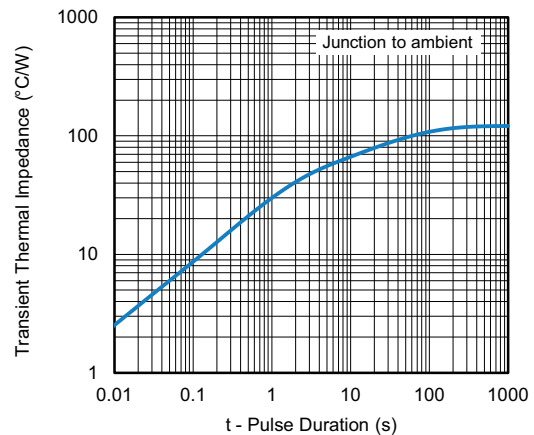
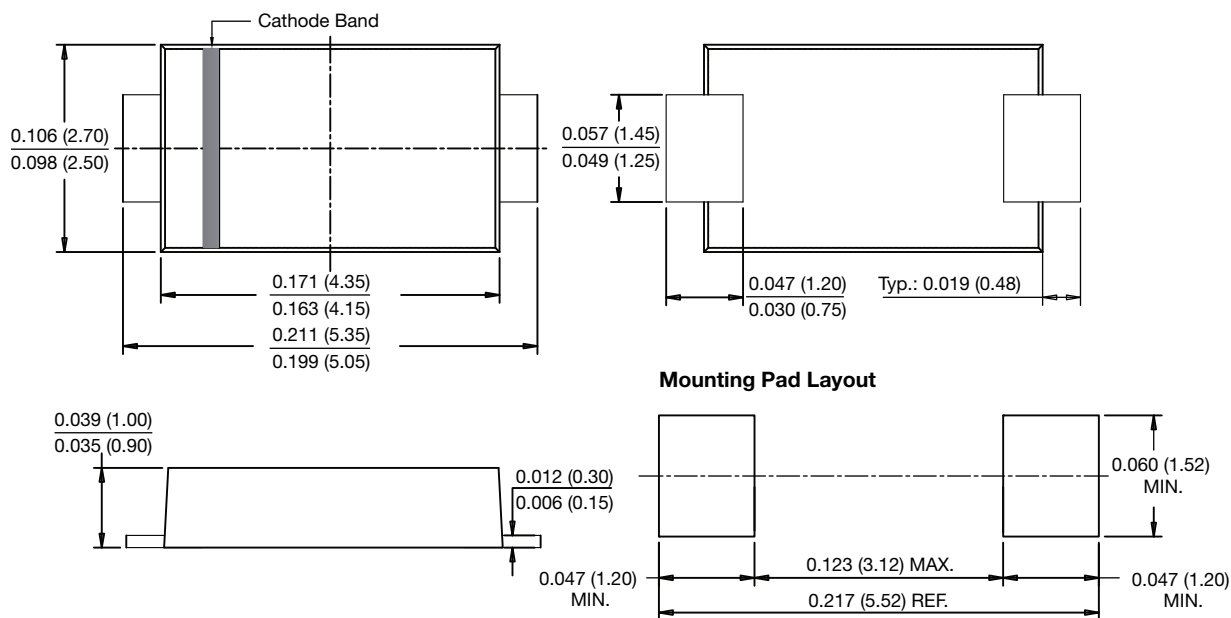


Fig. 6 - Typical Transient Thermal Impedance



PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SlimSMA (DO-221AC)





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